TS391, NCV391

Table 1. ABSOLUTE MAXIMUM RATINGS (Over operating free-air temperature, unless otherwise stated)

Parameter	Symbol	Limit	Unit
Supply Voltage (V _{CC} – V _{EE})	V _S	36	V
INPUT AND OUTPUT PINS			
Input Voltage	V _{IN}	-0.3 to 36	V
Differential Input Voltage	V _{ID}	±36	V
Output Short Circuit Current (Note 1)	I _{SC}	20	mA
TEMPERATURE			
Storage Temperature	T _{STG}	-65 to +150	°C
Junction Temperature	TJ	+150	°C
ESD RATINGS			
Human Body Model	НВМ	1500	V
Charged Device Model	CDM	2000	V
Machine Model	MM	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Short circuits from the output to V_{CC} can cause excessive heating and potential destruction. The maximum short circuit current is independent

Table 2. THERMAL INFORMATION (Note 2)

Thermal Metric	Symbol	Limit	Unit
Junction to Ambient – SOIC8	θ_{JA}	238	°C/W

^{2.} Short-circuits can cause excessive heating and destructive dissipation. These values are typical.

Table 3. OPERATING CONDITIONS

Parameter	Symbol	Limit	Unit
Operating Supply Voltage	V _S	2 to 36	V
Specified Operating Range	T _A	-40 to +125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

of the magnitude of V_{CC} .

TS391, NCV391

Table 4. ELECTRICAL CHARACTERISTICS (Vs=+5.0 V, At T_A = +25°C) Boldface limits apply over the specified temperature range, T_A = -40°C to +125°C.

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
INPUT CHARACTERISTIC	s						
Offset Voltage	V _{OS}	Vo = 1.4 V, R _S =	$V_{CM} = 0 \text{ to } V_{CC} - 1.5 \text{ V}$		1	5	mV
		$0 \Omega, V_S = 5 V \text{ to}$ 30 V	$V_{CM} = 0$ to $V_{CC} - 2$ V			9	mV
Input Bias Current	I _{IB}				25	250	nA
						400	nA
Input Offset Current	I _{OS}				5	50	nA
						150	nA
Input Common Mode	V _{ICR}			0		V _{CC} – 1.5	V
Range (Note 3)				0		V _{CC} – 2	٧
Differential Input Voltage (Note 4)	V _{ID}					V _{CC}	V
OUTPUT CHARACTERIST	TICS						
Output Voltage Low	V _{OL}	V _{ID} = 1 V, I _O = 4 mA		250	400	mV	
						700	mV
Output Sink Current	I _O	$V_{ID} = -1, V_{O} = 1.5 V$		6	16		mA
Output Leakage Current	I _{OH}	$V_{ID} = 1 \text{ V}, V_{CC} = V_{O} = 5 \text{ V}$ 0.1 $V_{ID} = 1 \text{ V}, V_{CC} = V_{O} = 30 \text{ V}$			nA		
						1	μΑ
DYNAMIC PERFORMANC	E						
Open Loop Voltage Gain	A _{VOL}	V _{CC} = 15	V , R_{PU} = 15 $kΩ$	94	106		dB
Propagation Delay L-H	t _{PLH}	5 mV overd	rive, $R_{PU} = 5.1 \text{ k}\Omega$		850		ns
		20 mV over	drive, $R_{PU} = 5.1 \text{ k}\Omega$		490		ns
		100 mV over	drive, $R_{PU} = 5.1 \text{ k}\Omega$		300		ns
		TTL Inpu R _{PI}	it, Vref = +1.4 V, $_{\rm J}$ = 5.1 k Ω		220		ns
Propagation Delay H-L	t _{PHL}	5 mV overd	drive, $R_{PU} = 5.1 \text{ k}\Omega$		620		ns
		20 mV over	drive, R _{PU} = 5.1 kΩ		400		ns
		100 mV over	drive, $R_{PU} = 5.1 \text{ k}\Omega$		250		ns
			t, Vref = +1.4 V, _U = 5.1 kΩ		350		ns
POWER SUPPLY							
Quiescent Current	I _{CC}	V	_{CC} = 5 V		0.5	-	mA
		Vo	_{CC} = 30 V		0.5	1.25	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{3.} The input common mode voltage of either input signal should not be allowed to go negative by more than 0.3 V. The upper end of the common mode voltage range is VCC – 1.5 V, but either or both inputs can go to +30 V without damage.

^{4.} Positive excursions of the input voltage may exceed the power supply level. As long as the other voltage remains within the common mode range, the comparator will provide a proper output stage. The low input voltage state must not be less than 0.3 V below the negative supply rail.

TS391, NCV391

TYPICAL CHARACTERISTICS

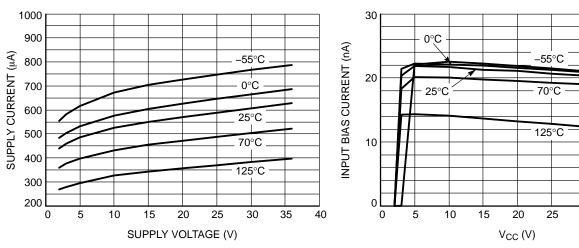


Figure 1. Supply Current vs. Supply Voltage



 $V_{IN} = 0 V$

35

40

30

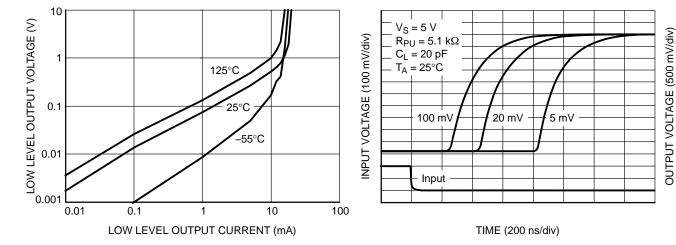


Figure 3. Low Level Output Voltage vs. Output
Current

Figure 4. Propagation Delay L-H vs. Overdrive

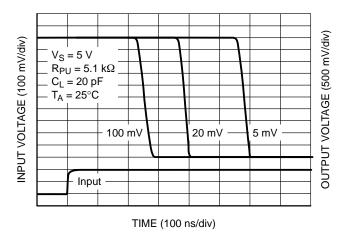
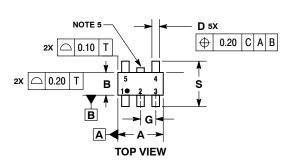


Figure 5. Propagation Delay H-L vs. Overdrive

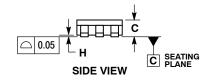


TSOP-5 **CASE 483 ISSUE N**

DATE 12 AUG 2020









NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A. OPTIONAL CONSTRUCTION: AN ADDITIONAL
- TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

	MILLIMETERS			
DIM	MIN	MAX		
Α	2.85	3.15		
В	1.35	1.65		
C	0.90	1.10		
D	0.25	0.50		
G	0.95 BSC			
Н	0.01	0.10		
J	0.10	0.26		
K	0.20	0.60		
М	0 °	10 °		
S	2 50	3.00		

SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*





XXX = Specific Device Code XXX = Specific Device Code

= Assembly Location = Date Code

= Year = Pb-Free Package

= Work Week W

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DOCUMENT NUMBER:	DCUMENT NUMBER: 98ARB18753C Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED O			
DESCRIPTION:	TSOP-5		PAGE 1 OF 1	

ON Semiconductor and unare trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi

TS391SN2T1G NCV391SN2T1G